

SN74AUC16245

16-BIT BUS TRANSCEIVER WITH 3-STATE OUTPUTS

SCES392E – MARCH 2002 – REVISED DECEMBER 2002

- Member of the Texas Instruments Widebus™ Family
- Optimized for 1.8-V Operation and is 3.6-V I/O Tolerant to Support Mixed-Mode Signal Operation
- I_{off} Supports Partial-Power-Down Mode Operation
- Sub 1-V Operable
- Max t_{pd} of 2 ns at 1.8 V
- Low Power Consumption, 20- μ A Max I_{CC}
- ± 8 -mA Output Drive at 1.8 V
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

description/ordering information

This 16-bit (dual-octal) noninverting bus transceiver is operational at 0.8-V to 2.7-V V_{CC} , but is designed specifically for 1.65-V to 1.95-V V_{CC} operation.

The SN74AUC16245 is designed for asynchronous communication between data buses. The control-function implementation minimizes external timing requirements.

This device can be used as two 8-bit transceivers or one 16-bit transceiver. It allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so that the buses are effectively isolated.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

DGG OR DGV PACKAGE (TOP VIEW)

1DIR	1	48	$\overline{1OE}$
1B1	2	47	1A1
1B2	3	46	1A2
GND	4	45	GND
1B3	5	44	1A3
1B4	6	43	1A4
V_{CC}	7	42	V_{CC}
1B5	8	41	1A5
1B6	9	40	1A6
GND	10	39	GND
1B7	11	38	1A7
1B8	12	37	1A8
2B1	13	36	2A1
2B2	14	35	2A2
GND	15	34	GND
2B3	16	33	2A3
2B4	17	32	2A4
V_{CC}	18	31	V_{CC}
2B5	19	30	2A5
2B6	20	29	2A6
GND	21	28	GND
2B7	22	27	2A7
2B8	23	26	2A8
2DIR	24	25	$\overline{2OE}$

ORDERING INFORMATION

T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	TSSOP – DGG	Tape and reel	SN74AUC16245DGGR	AUC16245
	TVSOP – DGV	Tape and reel	SN74AUC16245DGVR	MH245
	VFBGA – GQL	Tape and reel	SN74AUC16245GQLR	MH245

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

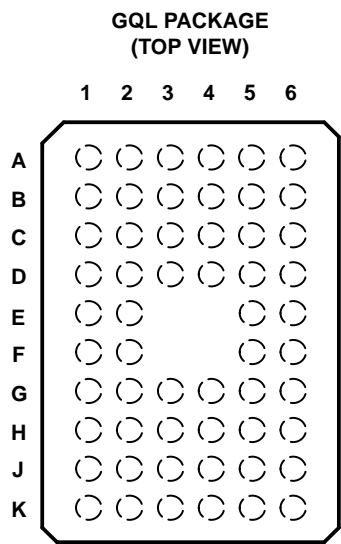
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terminal assignments

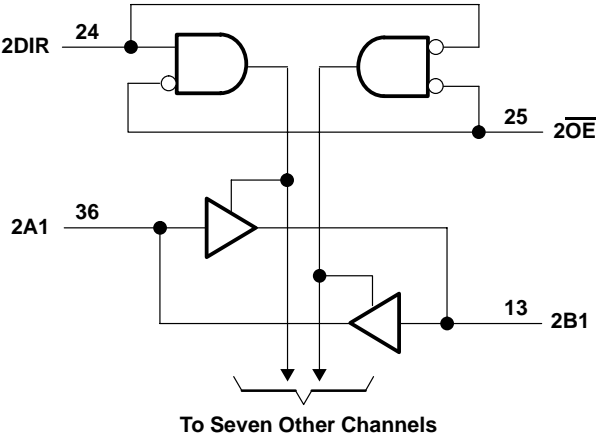
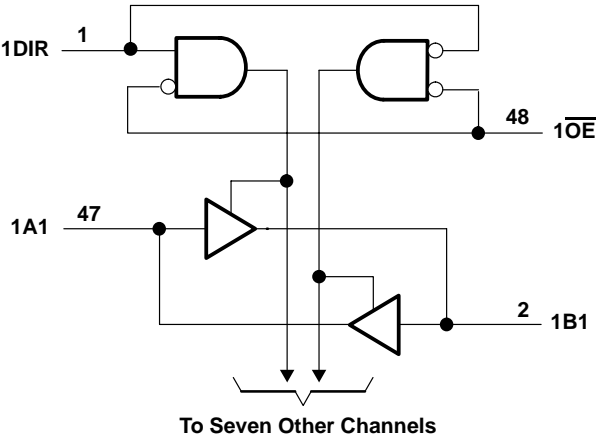
	1	2	3	4	5	6
A	1DIR	NC	NC	NC	NC	1OE
B	1B2	1B1	GND	GND	1A1	1A2
C	1B4	1B3	VCC	VCC	1A3	1A4
D	1B6	1B5	GND	GND	1A5	1A6
E	1B8	1B7			1A7	1A8
F	2B1	2B2			2A2	2A1
G	2B3	2B4	GND	GND	2A4	2A3
H	2B5	2B6	VCC	VCC	2A6	2A5
J	2B7	2B8	GND	GND	2A8	2A7
K	2DIR	NC	NC	NC	NC	2OE

NC – No internal connection

FUNCTION TABLE
(each 8-bit section)

INPUTS		OPERATION
OE	DIR	
L	L	B data to A bus
L	H	A data to B bus
H	X	Isolation

logic diagram (positive logic)



Pin numbers shown are for the DGG and DGV packages.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	–0.5 V to 3.6 V
Input voltage range, V_I (see Note 1)	–0.5 V to 3.6 V
Voltage range applied to any output in the high-impedance or power-off state, V_O (see Note 1)	–0.5 V to 3.6 V
Output voltage range, V_O (see Note 1)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	–50 mA
Output clamp current, I_{OK} ($V_O < 0$)	–50 mA
Continuous output current, I_O	±20 mA
Continuous current through V_{CC} or GND	±100 mA
Package thermal impedance, θ_{JA} (see Note 2): DGG package	70°C/W
DGV package	58°C/W
GQL package	42°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
V_{CC}	Supply voltage	0.8	2.7	V
V_{IH}	High-level input voltage	$V_{CC} = 0.8$ V	V_{CC}	V
		$V_{CC} = 1.1$ V to 1.95 V	$0.65 \times V_{CC}$	
		$V_{CC} = 2.3$ V to 2.7 V	1.7	
V_{IL}	Low-level input voltage	$V_{CC} = 0.8$ V	0	V
		$V_{CC} = 1.1$ V to 1.95 V	$0.35 \times V_{CC}$	
		$V_{CC} = 2.3$ V to 2.7 V	0.7	
V_I	Input voltage	0	3.6	V
V_O	Output voltage	Active state	0 V_{CC}	V
		3-state	0 3.6	
I_{OH}	High-level output current	$V_{CC} = 0.8$ V	–0.7	mA
		$V_{CC} = 1.1$ V	–3	
		$V_{CC} = 1.4$ V	–5	
		$V_{CC} = 1.65$ V	–8	
		$V_{CC} = 2.3$ V	–9	
I_{OL}	Low-level output current	$V_{CC} = 0.8$ V	0.7	mA
		$V_{CC} = 1.1$ V	3	
		$V_{CC} = 1.4$ V	5	
		$V_{CC} = 1.65$ V	8	
		$V_{CC} = 2.3$ V	9	
$\Delta t/\Delta v$	Input transition rise or fall rate		5	ns/V
T_A	Operating free-air temperature	–40	85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V _{CC}	MIN	TYP†	MAX	UNIT
V _{OH}		I _{OH} = –100 µA	0.8 V to 2.7 V	V _{CC} –0.1			V
		I _{OH} = –0.7 mA	0.8 V	0.55			
		I _{OH} = –3 mA	1.1 V	0.8			
		I _{OH} = –5 mA	1.4 V	1			
		I _{OH} = –8 mA	1.65 V	1.2			
		I _{OH} = –9 mA	2.3 V	1.8			
V _{OL}		I _{OL} = 100 µA	0.8 V to 2.7 V	0.2			V
		I _{OL} = 0.7 mA	0.8 V	0.25			
		I _{OL} = 3 mA	1.1 V	0.3			
		I _{OL} = 5 mA	1.4 V	0.4			
		I _{OL} = 8 mA	1.65 V	0.45			
		I _{OL} = 9 mA	2.3 V	0.6			
I _I	All inputs	V _I = V _{CC} or GND	0 to 2.7 V	±5			µA
I _{off}		V _I or V _O = 2.7 V	0	±10			µA
I _{OZ} ‡		V _O = V _{CC} or GND	2.7 V	±10			µA
I _{CC}		V _I = V _{CC} or GND, I _O = 0	0.8 V to 2.7 V	20			µA
C _i		V _I = V _{CC} or GND	2.5 V	3			pF
C _{io}		V _O = V _{CC} or GND	2.5 V	7			pF

† All typical values are at T_A = 25°C.

‡ For I/O ports, the parameter I_{OZ} includes the input leakage current.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 0.8 V	V _{CC} = 1.2 V ± 0.1 V		V _{CC} = 1.5 V ± 0.1 V		V _{CC} = 1.8 V ± 0.15 V			V _{CC} = 2.5 V ± 0.2 V		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	TYP	MAX	MIN	MAX	
t _{pd}	A or B	B or A	5.6	0.5	3.1	0.5	2	0.5	1.5	2	0.4	1.9	ns
t _{en}	$\overline{\text{OE}}$	A or B	10	0.7	4.6	0.7	3.1	0.7	2.1	3.1	0.7	2.6	ns
t _{dis}	$\overline{\text{OE}}$	A or B	12.8	0.8	6.8	0.8	5	0.8	3.4	4.8	0.5	2.9	ns

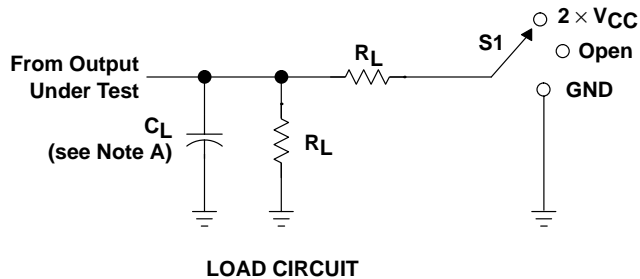
operating characteristics, T_A = 25°C

PARAMETER		TEST CONDITIONS	V _{CC} = 0.8 V	V _{CC} = 1.2 V	V _{CC} = 1.5 V	V _{CC} = 1.8 V	V _{CC} = 2.5 V	UNIT
			TYP	TYP	TYP	TYP	TYP	
C _{pd} Power dissipation capacitance	Outputs enabled	f = 10 MHz	22	23	24	25	29	pF
	Outputs disabled		1	1	1	1	1	

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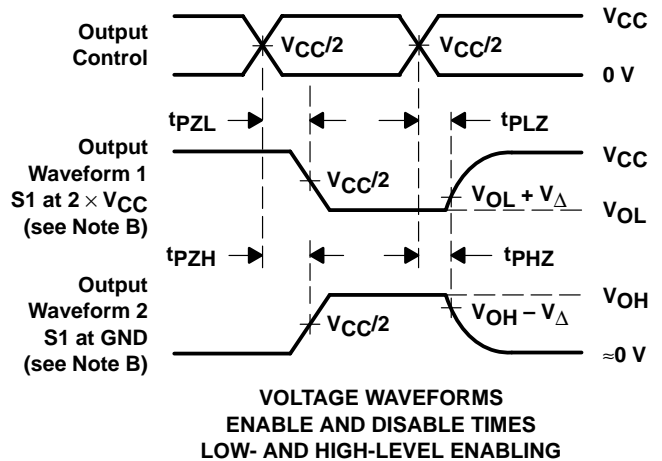
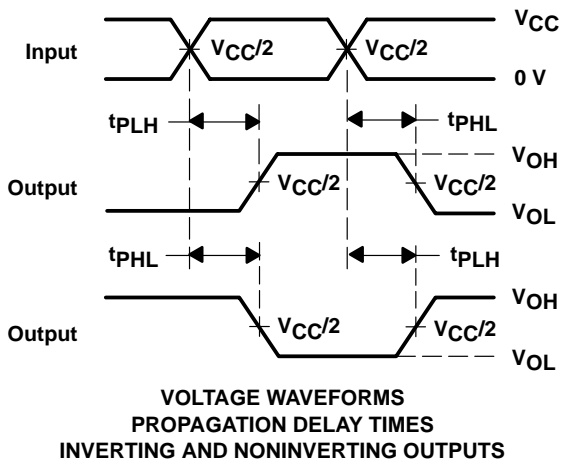
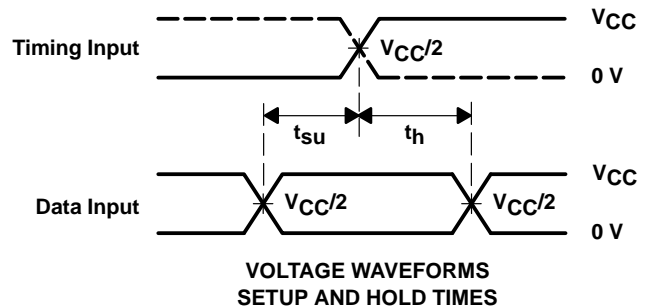
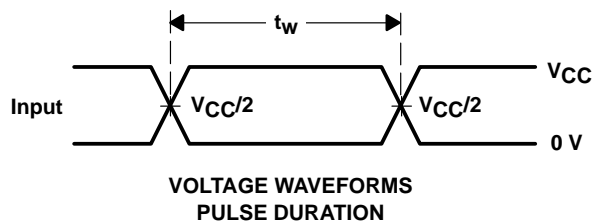
SCES392E – MARCH 2002 – REVISED DECEMBER 2002

PARAMETER MEASUREMENT INFORMATION



TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	$2 \times V_{CC}$
t_{PHZ}/t_{PZH}	GND

V_{CC}	C_L	R_L	V_{Δ}
0.8 V	15 pF	2 k Ω	0.1 V
1.2 V \pm 0.1 V	15 pF	2 k Ω	0.1 V
1.5 V \pm 0.1 V	15 pF	2 k Ω	0.1 V
1.8 V \pm 0.15 V	30 pF	1 k Ω	0.15 V
2.5 V \pm 0.2 V	30 pF	500 Ω	0.15 V



- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, slew rate \geq 1 V/ns.
 - The outputs are measured one at a time with one transition per measurement.
 - t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - t_{PZL} and t_{PZH} are the same as t_{en} .
 - t_{PLH} and t_{PHL} are the same as t_{pd} .
 - All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

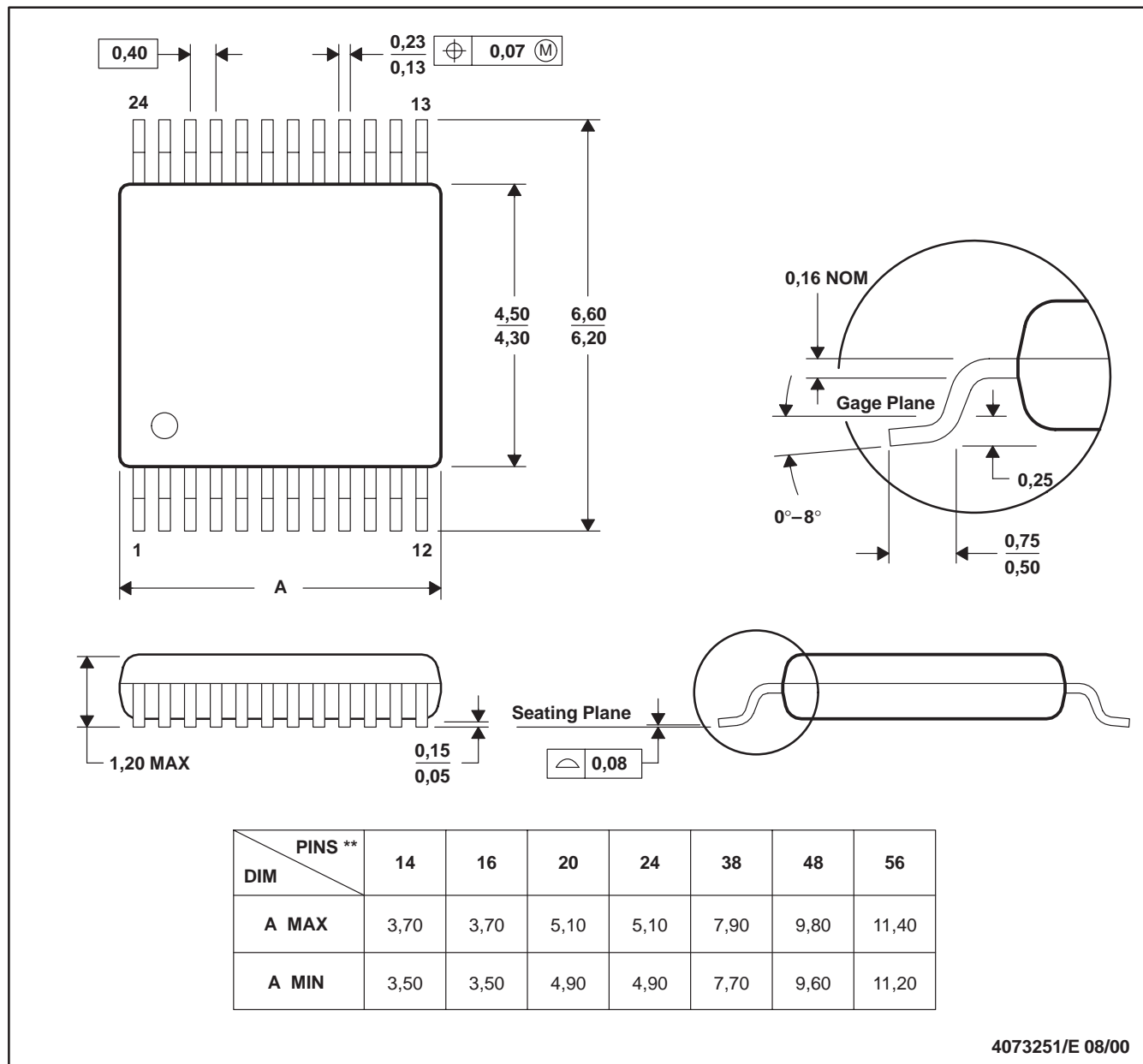
MECHANICAL DATA

MPDS006C – FEBRUARY 1996 – REVISED AUGUST 2000

DGV (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

24 PINS SHOWN

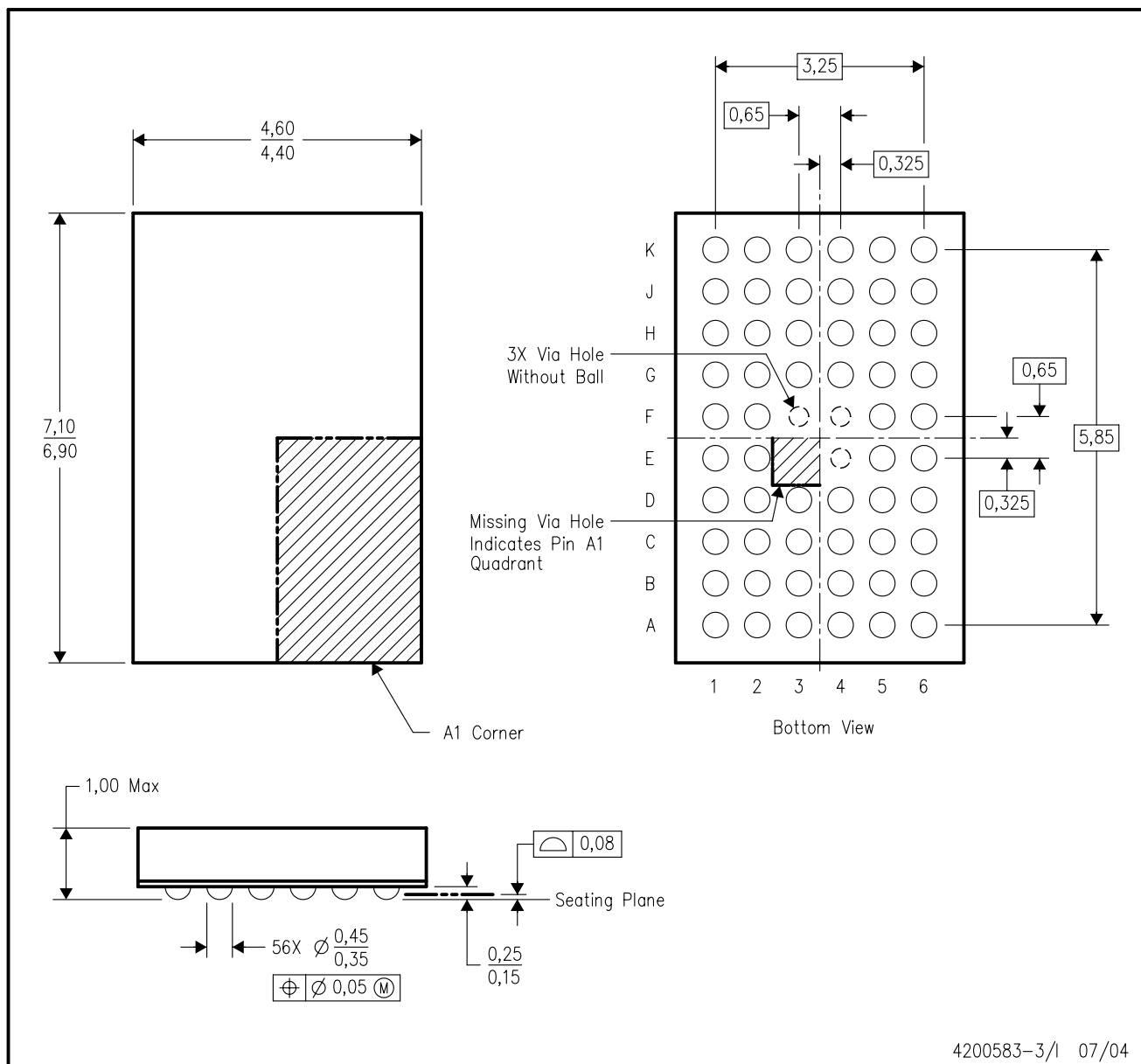


- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
 D. Falls within JEDEC: 24/48 Pins – MO-153
 14/16/20/56 Pins – MO-194

MECHANICAL DATA

GQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Falls within JEDEC MO-225 variation BA.
 - This package is tin-lead (SnPb). Refer to the 56 ZQL package (drawing 4204437) for lead-free.

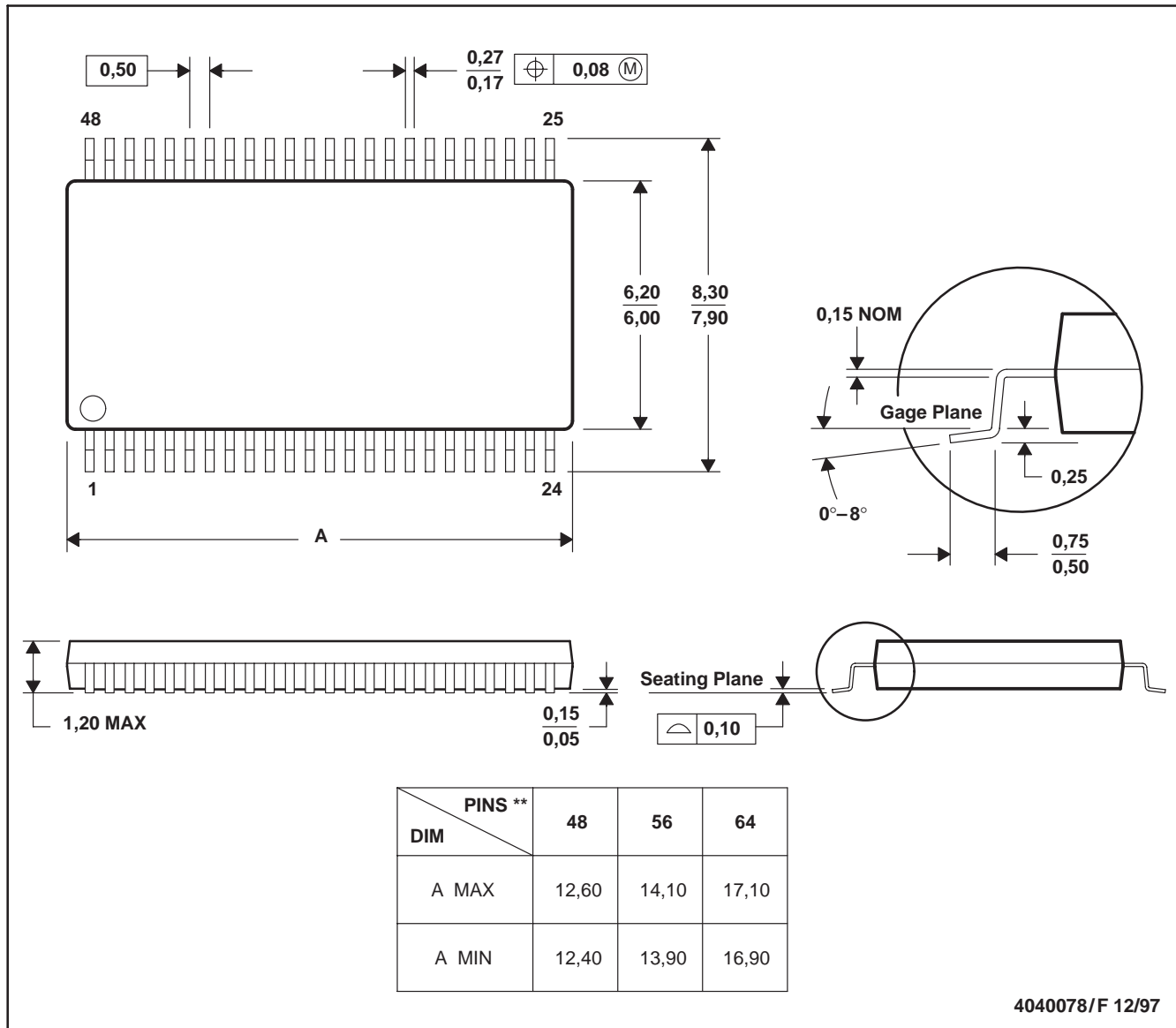
MECHANICAL DATA

MTSS003D – JANUARY 1995 – REVISED JANUARY 1998

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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